

IC Substrate Industry Research Report 2023

https://marketpublishers.com/r/IA0E87F769ADEN.html

Date: August 2023

Pages: 120

Price: US\$ 2,950.00 (Single User License)

ID: IA0E87F769ADEN

Abstracts

This report aims to provide a comprehensive presentation of the global market for IC Substrate, with both quantitative and qualitative analysis, to help readers develop business/growth strategies, assess the market competitive situation, analyze their position in the current marketplace, and make informed business decisions regarding IC Substrate.

The IC Substrate market size, estimations, and forecasts are provided in terms of output/shipments (K Sqm) and revenue (\$ millions), considering 2022 as the base year, with history and forecast data for the period from 2018 to 2029. This report segments the global IC Substrate market comprehensively. Regional market sizes, concerning products by types, by application, and by players, are also provided. The influence of COVID-19 and the Russia-Ukraine War were considered while estimating market sizes.

For a more in-depth understanding of the market, the report provides profiles of the competitive landscape, key competitors, and their respective market ranks. The report also discusses technological trends and new product developments.

The report will help the IC Substrate manufacturers, new entrants, and industry chain related companies in this market with information on the revenues, production, and average price for the overall market and the sub-segments across the different segments, by company, product type, application, and regions.

Key Companies & Market Share Insights

In this section, the readers will gain an understanding of the key players competing. This report has studied the key growth strategies, such as innovative trends and developments, intensification of product portfolio, mergers and acquisitions, collaborations, new product innovation, and geographical expansion, undertaken by



these participants to maintain their presence. Apart from business strategies, the study includes current developments and key financials. The readers will also get access to the data related to global revenue, price, and sales by manufacturers for the period 2018-2023. This all-inclusive report will certainly serve the clients to stay updated and make effective decisions in their businesses. Some of the prominent players reviewed in the research report include:

Unimicron
Ibiden
Nan Ya PCB
Shinko Electric Industries
Kinsus Interconnect Technology
AT&S
Semco
Kyocera
TOPPAN
Zhen Ding Technology
Daeduck Electronics
ASE Material
LG InnoTek
Simmtech
Shennan Circuit
Shenzhen Fastprint Circuit Tech



ACCESS
Suntak Technology
National Center for Advanced Packaging (NCAP China)
Huizhou China Eagle Electronic Technology
DSBJ
Shenzhen Kinwong Electronic
AKM Meadville

Product Type Insights

Victory Giant Technology

Global markets are presented by IC Substrate type, along with growth forecasts through 2029. Estimates on production and value are based on the price in the supply chain at which the IC Substrate are procured by the manufacturers.

This report has studied every segment and provided the market size using historical data. They have also talked about the growth opportunities that the segment may pose in the future. This study bestows production and revenue data by type, and during the historical period (2018-2023) and forecast period (2024-2029).

IC Substrate segment by Type

FC-BGA

FC-CSP

WB BGA

WB CSP

Others



Application Insights

This report has provided the market size (production and revenue data) by application, during the historical period (2018-2023) and forecast period (2024-2029).

This report also outlines the market trends of each segment and consumer behaviors impacting the IC Substrate market and what implications these may have on the industry's future. This report can help to understand the relevant market and consumer trends that are driving the IC Substrate market.

IC Substrate segment by Application

Smart Phones

PC (Tablet, Laptop)

Wearable Devices

Others

Regional Outlook

This section of the report provides key insights regarding various regions and the key players operating in each region. Economic, social, environmental, technological, and political factors have been taken into consideration while assessing the growth of the particular region/country. The readers will also get their hands on the revenue and sales data of each region and country for the period 2018-2029.

The market has been segmented into various major geographies, including North America, Europe, Asia-Pacific, South America. Detailed analysis of major countries such as the USA, Germany, the U.K., Italy, France, China, Japan, South Korea, Southeast Asia, and India will be covered within the regional segment. For market estimates, data are going to be provided for 2022 because of the base year, with estimates for 2023 and forecast value for 2029.

North America



	United States
	Canada
Europe)
	Germany
	France
	U.K.
	Italy
	Russia
Asia-Pacific	
	China
	Japan
	South Korea
	India
	Australia
	China Taiwan
	Indonesia
	Thailand
	Malaysia

Latin America



Mexico

Brazil

Argentina

Key Drivers & Barriers

High-impact rendering factors and drivers have been studied in this report to aid the readers to understand the general development. Moreover, the report includes restraints and challenges that may act as stumbling blocks on the way of the players. This will assist the users to be attentive and make informed decisions related to business. Specialists have also laid their focus on the upcoming business prospects.

COVID-19 and Russia-Ukraine War Influence Analysis

The readers in the section will understand how the IC Substrate market scenario changed across the globe during the pandemic, post-pandemic and Russia-Ukraine War. The study is done keeping in view the changes in aspects such as demand, consumption, transportation, consumer behavior, supply chain management, export and import, and production. The industry experts have also highlighted the key factors that will help create opportunities for players and stabilize the overall industry in the years to come.

Reasons to Buy This Report

This report will help the readers to understand the competition within the industries and strategies for the competitive environment to enhance the potential profit. The report also focuses on the competitive landscape of the global IC Substrate market, and introduces in detail the market share, industry ranking, competitor ecosystem, market performance, new product development, operation situation, expansion, and acquisition. etc. of the main players, which helps the readers to identify the main competitors and deeply understand the competition pattern of the market.

This report will help stakeholders to understand the global industry status and trends of IC Substrate and provides them with information on key market drivers, restraints, challenges, and opportunities.



This report will help stakeholders to understand competitors better and gain more insights to strengthen their position in their businesses. The competitive landscape section includes the market share and rank (in volume and value), competitor ecosystem, new product development, expansion, and acquisition.

This report stays updated with novel technology integration, features, and the latest developments in the market

This report helps stakeholders to understand the COVID-19 and Russia-Ukraine War Influence on the IC Substrate industry.

This report helps stakeholders to gain insights into which regions to target globally

This report helps stakeholders to gain insights into the end-user perception concerning the adoption of IC Substrate.

This report helps stakeholders to identify some of the key players in the market and understand their valuable contribution.

Core Chapters

Chapter 1: Research objectives, research methods, data sources, data cross-validation;

Chapter 2: Introduces the report scope of the report, executive summary of different market segments (by region, product type, application, etc), including the market size of each market segment, future development potential, and so on. It offers a high-level view of the current state of the market and its likely evolution in the short to mid-term, and long term.

Chapter 3: Detailed analysis of IC Substrate manufacturers competitive landscape, price, production and value market share, latest development plan, merger, and acquisition information, etc.

Chapter 4: Provides profiles of key players, introducing the basic situation of the main companies in the market in detail, including product production/output, value, price, gross margin, product introduction, recent development, etc.

Chapter 5: Production/output, value of IC Substrate by region/country. It provides a quantitative analysis of the market size and development potential of each region in the



next six years.

Chapter 6: Consumption of IC Substrate in regional level and country level. It provides a quantitative analysis of the market size and development potential of each region and its main countries and introduces the market development, future development prospects, market space, and production of each country in the world.

Chapter 7: Provides the analysis of various market segments by type, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different market segments.

Chapter 8: Provides the analysis of various market segments by application, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different downstream markets.

Chapter 9: Analysis of industrial chain, including the upstream and downstream of the industry.

Chapter 10: Introduces the market dynamics, latest developments of the market, the driving factors and restrictive factors of the market, the challenges and risks faced by manufacturers in the industry, and the analysis of relevant policies in the industry.

Chapter 11: The main points and conclusions of the report.



Contents

1 PREFACE

- 1.1 Scope of Report
- 1.2 Reasons for Doing This Study
- 1.3 Research Methodology
- 1.4 Research Process
- 1.5 Data Source
 - 1.5.1 Secondary Sources
 - 1.5.2 Primary Sources

2 MARKET OVERVIEW

- 2.1 Product Definition
- 2.2 IC Substrate by Type
 - 2.2.1 Market Value Comparison by Type (2018 VS 2022 VS 2029) & (US\$ Million)
 - 1.2.2 FC-BGA
 - 1.2.3 FC-CSP
 - 1.2.4 WB BGA
 - 1.2.5 WB CSP
 - 1.2.6 Others
- 2.3 IC Substrate by Application
- 2.3.1 Market Value Comparison by Application (2018 VS 2022 VS 2029) & (US\$ Million)
 - 2.3.2 Smart Phones
 - 2.3.3 PC (Tablet, Laptop)
 - 2.3.4 Wearable Devices
 - 2.3.5 Others
- 2.4 Global Market Growth Prospects
 - 2.4.1 Global IC Substrate Production Value Estimates and Forecasts (2018-2029)
- 2.4.2 Global IC Substrate Production Capacity Estimates and Forecasts (2018-2029)
- 2.4.3 Global IC Substrate Production Estimates and Forecasts (2018-2029)
- 2.4.4 Global IC Substrate Market Average Price (2018-2029)

3 MARKET COMPETITIVE LANDSCAPE BY MANUFACTURERS

- 3.1 Global IC Substrate Production by Manufacturers (2018-2023)
- 3.2 Global IC Substrate Production Value by Manufacturers (2018-2023)



- 3.3 Global IC Substrate Average Price by Manufacturers (2018-2023)
- 3.4 Global IC Substrate Industry Manufacturers Ranking, 2021 VS 2022 VS 2023
- 3.5 Global IC Substrate Key Manufacturers, Manufacturing Sites & Headquarters
- 3.6 Global IC Substrate Manufacturers, Product Type & Application
- 3.7 Global IC Substrate Manufacturers, Date of Enter into This Industry
- 3.8 Global IC Substrate Market CR5 and HHI
- 3.9 Global Manufacturers Mergers & Acquisition

4 MANUFACTURERS PROFILED

- 4.1 Unimicron
 - 4.1.1 Unimicron IC Substrate Company Information
 - 4.1.2 Unimicron IC Substrate Business Overview
- 4.1.3 Unimicron IC Substrate Production, Value and Gross Margin (2018-2023)
- 4.1.4 Unimicron Product Portfolio
- 4.1.5 Unimicron Recent Developments
- 4.2 Ibiden
 - 4.2.1 Ibiden IC Substrate Company Information
 - 4.2.2 Ibiden IC Substrate Business Overview
 - 4.2.3 Ibiden IC Substrate Production, Value and Gross Margin (2018-2023)
 - 4.2.4 Ibiden Product Portfolio
 - 4.2.5 Ibiden Recent Developments
- 4.3 Nan Ya PCB
 - 4.3.1 Nan Ya PCB IC Substrate Company Information
 - 4.3.2 Nan Ya PCB IC Substrate Business Overview
 - 4.3.3 Nan Ya PCB IC Substrate Production, Value and Gross Margin (2018-2023)
 - 4.3.4 Nan Ya PCB Product Portfolio
 - 4.3.5 Nan Ya PCB Recent Developments
- 4.4 Shinko Electric Industries
 - 4.4.1 Shinko Electric Industries IC Substrate Company Information
 - 4.4.2 Shinko Electric Industries IC Substrate Business Overview
- 4.4.3 Shinko Electric Industries IC Substrate Production, Value and Gross Margin (2018-2023)
- 4.4.4 Shinko Electric Industries Product Portfolio
- 4.4.5 Shinko Electric Industries Recent Developments
- 4.5 Kinsus Interconnect Technology
 - 4.5.1 Kinsus Interconnect Technology IC Substrate Company Information
 - 4.5.2 Kinsus Interconnect Technology IC Substrate Business Overview
- 4.5.3 Kinsus Interconnect Technology IC Substrate Production, Value and Gross



Margin (2018-2023)

- 4.5.4 Kinsus Interconnect Technology Product Portfolio
- 4.5.5 Kinsus Interconnect Technology Recent Developments

4.6 AT&S

- 4.6.1 AT&S IC Substrate Company Information
- 4.6.2 AT&S IC Substrate Business Overview
- 4.6.3 AT&S IC Substrate Production, Value and Gross Margin (2018-2023)
- 4.6.4 AT&S Product Portfolio
- 4.6.5 AT&S Recent Developments

4.7 Semco

- 4.7.1 Semco IC Substrate Company Information
- 4.7.2 Semco IC Substrate Business Overview
- 4.7.3 Semco IC Substrate Production, Value and Gross Margin (2018-2023)
- 4.7.4 Semco Product Portfolio
- 4.7.5 Semco Recent Developments

4.8 Kyocera

- 4.8.1 Kyocera IC Substrate Company Information
- 4.8.2 Kyocera IC Substrate Business Overview
- 4.8.3 Kyocera IC Substrate Production, Value and Gross Margin (2018-2023)
- 4.8.4 Kyocera Product Portfolio
- 4.8.5 Kyocera Recent Developments

4.9 TOPPAN

- 4.9.1 TOPPAN IC Substrate Company Information
- 4.9.2 TOPPAN IC Substrate Business Overview
- 4.9.3 TOPPAN IC Substrate Production, Value and Gross Margin (2018-2023)
- 4.9.4 TOPPAN Product Portfolio
- 4.9.5 TOPPAN Recent Developments
- 4.10 Zhen Ding Technology
 - 4.10.1 Zhen Ding Technology IC Substrate Company Information
 - 4.10.2 Zhen Ding Technology IC Substrate Business Overview
- 4.10.3 Zhen Ding Technology IC Substrate Production, Value and Gross Margin (2018-2023)
- 4.10.4 Zhen Ding Technology Product Portfolio
- 4.10.5 Zhen Ding Technology Recent Developments
- 7.11 Daeduck Electronics
 - 7.11.1 Daeduck Electronics IC Substrate Company Information
 - 7.11.2 Daeduck Electronics IC Substrate Business Overview
- 4.11.3 Daeduck Electronics IC Substrate Production, Value and Gross Margin (2018-2023)



- 7.11.4 Daeduck Electronics Product Portfolio
- 7.11.5 Daeduck Electronics Recent Developments
- 7.12 ASE Material
 - 7.12.1 ASE Material IC Substrate Company Information
 - 7.12.2 ASE Material IC Substrate Business Overview
 - 7.12.3 ASE Material IC Substrate Production, Value and Gross Margin (2018-2023)
 - 7.12.4 ASE Material Product Portfolio
 - 7.12.5 ASE Material Recent Developments
- 7.13 LG InnoTek
 - 7.13.1 LG InnoTek IC Substrate Company Information
 - 7.13.2 LG InnoTek IC Substrate Business Overview
 - 7.13.3 LG InnoTek IC Substrate Production, Value and Gross Margin (2018-2023)
 - 7.13.4 LG InnoTek Product Portfolio
 - 7.13.5 LG InnoTek Recent Developments
- 7.14 Simmtech
 - 7.14.1 Simmtech IC Substrate Company Information
 - 7.14.2 Simmtech IC Substrate Business Overview
 - 7.14.3 Simmtech IC Substrate Production, Value and Gross Margin (2018-2023)
 - 7.14.4 Simmtech Product Portfolio
 - 7.14.5 Simmtech Recent Developments
- 7.15 Shennan Circuit
 - 7.15.1 Shennan Circuit IC Substrate Company Information
 - 7.15.2 Shennan Circuit IC Substrate Business Overview
 - 7.15.3 Shennan Circuit IC Substrate Production, Value and Gross Margin (2018-2023)
 - 7.15.4 Shennan Circuit Product Portfolio
 - 7.15.5 Shennan Circuit Recent Developments
- 7.16 Shenzhen Fastprint Circuit Tech
 - 7.16.1 Shenzhen Fastprint Circuit Tech IC Substrate Company Information
 - 7.16.2 Shenzhen Fastprint Circuit Tech IC Substrate Business Overview
- 7.16.3 Shenzhen Fastprint Circuit Tech IC Substrate Production, Value and Gross Margin (2018-2023)
 - 7.16.4 Shenzhen Fastprint Circuit Tech Product Portfolio
 - 7.16.5 Shenzhen Fastprint Circuit Tech Recent Developments
- 7.17 ACCESS
 - 7.17.1 ACCESS IC Substrate Company Information
 - 7.17.2 ACCESS IC Substrate Business Overview
 - 7.17.3 ACCESS IC Substrate Production, Value and Gross Margin (2018-2023)
 - 7.17.4 ACCESS Product Portfolio
 - 7.17.5 ACCESS Recent Developments



- 7.18 Suntak Technology
 - 7.18.1 Suntak Technology IC Substrate Company Information
 - 7.18.2 Suntak Technology IC Substrate Business Overview
- 7.18.3 Suntak Technology IC Substrate Production, Value and Gross Margin (2018-2023)
 - 7.18.4 Suntak Technology Product Portfolio
- 7.18.5 Suntak Technology Recent Developments
- 7.19 National Center for Advanced Packaging (NCAP China)
- 7.19.1 National Center for Advanced Packaging (NCAP China) IC Substrate Company Information
- 7.19.2 National Center for Advanced Packaging (NCAP China) IC Substrate Business Overview
- 7.19.3 National Center for Advanced Packaging (NCAP China) IC Substrate Production, Value and Gross Margin (2018-2023)
- 7.19.4 National Center for Advanced Packaging (NCAP China) Product Portfolio
- 7.19.5 National Center for Advanced Packaging (NCAP China) Recent Developments
- 7.20 Huizhou China Eagle Electronic Technology
 - 7.20.1 Huizhou China Eagle Electronic Technology IC Substrate Company Information
 - 7.20.2 Huizhou China Eagle Electronic Technology IC Substrate Business Overview
- 7.20.3 Huizhou China Eagle Electronic Technology IC Substrate Production, Value and Gross Margin (2018-2023)
 - 7.20.4 Huizhou China Eagle Electronic Technology Product Portfolio
- 7.20.5 Huizhou China Eagle Electronic Technology Recent Developments

7.21 DSBJ

- 7.21.1 DSBJ IC Substrate Company Information
- 7.21.2 DSBJ IC Substrate Business Overview
- 7.21.3 DSBJ IC Substrate Production, Value and Gross Margin (2018-2023)
- 7.21.4 DSBJ Product Portfolio
- 7.21.5 DSBJ Recent Developments
- 7.22 Shenzhen Kinwong Electronic
 - 7.22.1 Shenzhen Kinwong Electronic IC Substrate Company Information
 - 7.22.2 Shenzhen Kinwong Electronic IC Substrate Business Overview
- 7.22.3 Shenzhen Kinwong Electronic IC Substrate Production, Value and Gross Margin (2018-2023)
 - 7.22.4 Shenzhen Kinwong Electronic Product Portfolio
 - 7.22.5 Shenzhen Kinwong Electronic Recent Developments
- 7.23 AKM Meadville
- 7.23.1 AKM Meadville IC Substrate Company Information
- 7.23.2 AKM Meadville IC Substrate Business Overview



- 7.23.3 AKM Meadville IC Substrate Production, Value and Gross Margin (2018-2023)
- 7.23.4 AKM Meadville Product Portfolio
- 7.23.5 AKM Meadville Recent Developments
- 7.24 Victory Giant Technology
- 7.24.1 Victory Giant Technology IC Substrate Company Information
- 7.24.2 Victory Giant Technology IC Substrate Business Overview
- 7.24.3 Victory Giant Technology IC Substrate Production, Value and Gross Margin (2018-2023)
 - 7.24.4 Victory Giant Technology Product Portfolio
- 7.24.5 Victory Giant Technology Recent Developments

5 GLOBAL IC SUBSTRATE PRODUCTION BY REGION

- 5.1 Global IC Substrate Production Estimates and Forecasts by Region: 2018 VS 2022 VS 2029
- 5.2 Global IC Substrate Production by Region: 2018-2029
- 5.2.1 Global IC Substrate Production by Region: 2018-2023
- 5.2.2 Global IC Substrate Production Forecast by Region (2024-2029)
- 5.3 Global IC Substrate Production Value Estimates and Forecasts by Region: 2018 VS 2022 VS 2029
- 5.4 Global IC Substrate Production Value by Region: 2018-2029
 - 5.4.1 Global IC Substrate Production Value by Region: 2018-2023
- 5.4.2 Global IC Substrate Production Value Forecast by Region (2024-2029)
- 5.5 Global IC Substrate Market Price Analysis by Region (2018-2023)
- 5.6 Global IC Substrate Production and Value, YOY Growth
 - 5.6.1 China IC Substrate Production Value Estimates and Forecasts (2018-2029)
- 5.6.2 China Taiwan IC Substrate Production Value Estimates and Forecasts (2018-2029)
- 5.6.3 Japan IC Substrate Production Value Estimates and Forecasts (2018-2029)
- 5.6.4 South Korea IC Substrate Production Value Estimates and Forecasts (2018-2029)
- 5.6.5 Southeast Asia IC Substrate Production Value Estimates and Forecasts (2018-2029)

6 GLOBAL IC SUBSTRATE CONSUMPTION BY REGION

- 6.1 Global IC Substrate Consumption Estimates and Forecasts by Region: 2018 VS 2022 VS 2029
- 6.2 Global IC Substrate Consumption by Region (2018-2029)



- 6.2.1 Global IC Substrate Consumption by Region: 2018-2029
- 6.2.2 Global IC Substrate Forecasted Consumption by Region (2024-2029)
- 6.3 North America
- 6.3.1 North America IC Substrate Consumption Growth Rate by Country: 2018 VS 2022 VS 2029
 - 6.3.2 North America IC Substrate Consumption by Country (2018-2029)
 - 6.3.3 United States
 - 6.3.4 Canada
- 6.4 Europe
- 6.4.1 Europe IC Substrate Consumption Growth Rate by Country: 2018 VS 2022 VS 2029
 - 6.4.2 Europe IC Substrate Consumption by Country (2018-2029)
 - 6.4.3 Germany
 - 6.4.4 France
 - 6.4.5 U.K.
 - 6.4.6 Italy
 - 6.4.7 Russia
- 6.5 Asia Pacific
- 6.5.1 Asia Pacific IC Substrate Consumption Growth Rate by Country: 2018 VS 2022 VS 2029
 - 6.5.2 Asia Pacific IC Substrate Consumption by Country (2018-2029)
 - 6.5.3 China
 - 6.5.4 Japan
 - 6.5.5 South Korea
 - 6.5.6 China Taiwan
 - 6.5.7 Southeast Asia
 - 6.5.8 India
 - 6.5.9 Australia
- 6.6 Latin America, Middle East & Africa
- 6.6.1 Latin America, Middle East & Africa IC Substrate Consumption Growth Rate by Country: 2018 VS 2022 VS 2029
- 6.6.2 Latin America, Middle East & Africa IC Substrate Consumption by Country (2018-2029)
 - 6.6.3 Mexico
 - 6.6.4 Brazil
 - 6.6.5 Turkey
 - 6.6.5 GCC Countries

7 SEGMENT BY TYPE



- 7.1 Global IC Substrate Production by Type (2018-2029)
 - 7.1.1 Global IC Substrate Production by Type (2018-2029) & (K Sqm)
 - 7.1.2 Global IC Substrate Production Market Share by Type (2018-2029)
- 7.2 Global IC Substrate Production Value by Type (2018-2029)
 - 7.2.1 Global IC Substrate Production Value by Type (2018-2029) & (US\$ Million)
- 7.2.2 Global IC Substrate Production Value Market Share by Type (2018-2029)
- 7.3 Global IC Substrate Price by Type (2018-2029)

8 SEGMENT BY APPLICATION

- 8.1 Global IC Substrate Production by Application (2018-2029)
 - 8.1.1 Global IC Substrate Production by Application (2018-2029) & (K Sqm)
 - 8.1.2 Global IC Substrate Production by Application (2018-2029) & (K Sqm)
- 8.2 Global IC Substrate Production Value by Application (2018-2029)
- 8.2.1 Global IC Substrate Production Value by Application (2018-2029) & (US\$ Million)
- 8.2.2 Global IC Substrate Production Value Market Share by Application (2018-2029)
- 8.3 Global IC Substrate Price by Application (2018-2029)

9 VALUE CHAIN AND SALES CHANNELS ANALYSIS OF THE MARKET

- 9.1 IC Substrate Value Chain Analysis
 - 9.1.1 IC Substrate Key Raw Materials
 - 9.1.2 Raw Materials Key Suppliers
 - 9.1.3 IC Substrate Production Mode & Process
- 9.2 IC Substrate Sales Channels Analysis
 - 9.2.1 Direct Comparison with Distribution Share
 - 9.2.2 IC Substrate Distributors
 - 9.2.3 IC Substrate Customers

10 GLOBAL IC SUBSTRATE ANALYZING MARKET DYNAMICS

- 10.1 IC Substrate Industry Trends
- 10.2 IC Substrate Industry Drivers
- 10.3 IC Substrate Industry Opportunities and Challenges
- 10.4 IC Substrate Industry Restraints

11 REPORT CONCLUSION



12 DISCLAIMER



I would like to order

Product name: IC Substrate Industry Research Report 2023

Product link: https://marketpublishers.com/r/IA0E87F769ADEN.html

Price: US\$ 2,950.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer

Service:

info@marketpublishers.com

Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page https://marketpublishers.com/r/IA0E87F769ADEN.html

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:	
Last name:	
Email:	
Company:	
Address:	
City:	
Zip code:	
Country:	
Tel:	
Fax:	
Your message:	
	**All fields are required
	Custumer signature

& Conditions at https://marketpublishers.com/docs/terms.html

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970